



Product Change Notification

Change Notification #: 115396 - 00
Change Title: Intel® Ethernet Converged Network Adapter X710-T4, Product Code X710T4G1P5 MM#943101, Intel® Ethernet Converged Network Adapter X710-T4, Product Code X710T4BLK MM#943053, Intel® Ethernet Converged Network Adapter X710-T4, Product Code X710T4 MM# 943052, PCN 115396-00, Product Material, Label, Transport Media, PBA Update and Clamshell Update
Date of Publication: April 07, 2017

Key Characteristics of the Change:

Product Material, Label, Transport Media

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Apr 28, 2017
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Description of Change to the Customer:

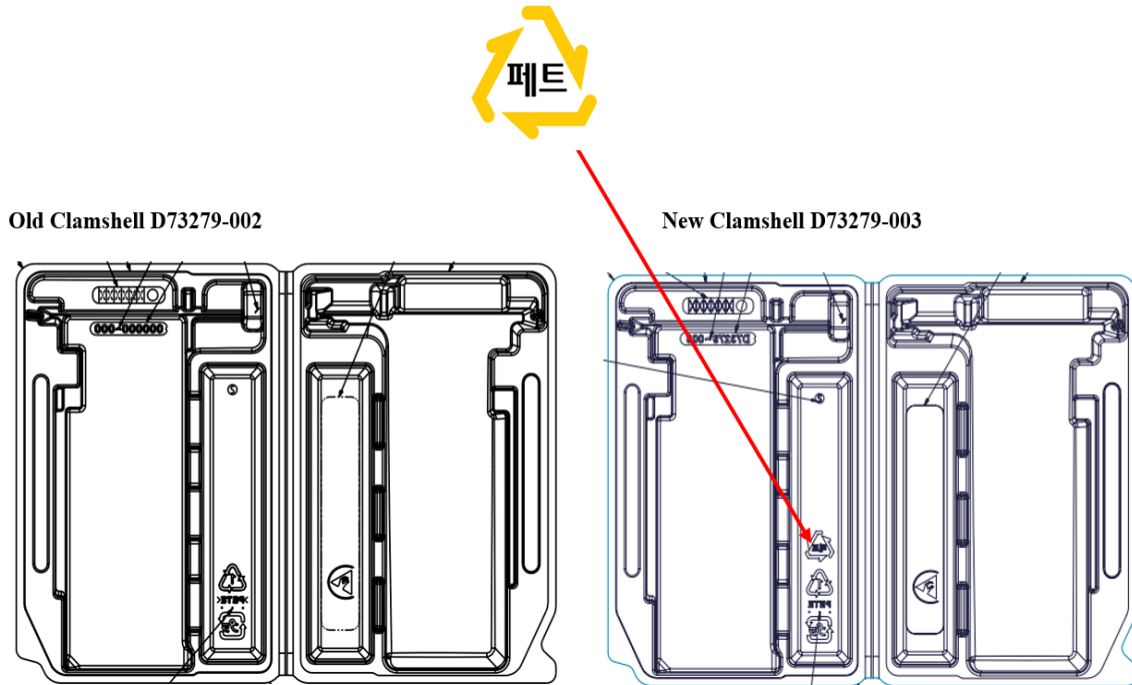
The following products will undergo changes:

Marketing Name	Product Code (DPN)	MM#
Intel® Eth Converged Network Adapter X710-T4	X710T4G1P5	943101
Intel® Eth Converged Network Adapter X710-T4	X710T4	943052
Intel® Eth Converged Network Adapter X710-T4	X710T4BLK	943053

The following describes the changes being made:

- OEM-Gen - Intel® Eth Converged Nw Adapter X710-T4 Product Code X710T4G1P5 MM#943101
 - Replace PBA J64862-012 with PBA J64862-013.
 - Replace clamshell D73279-002 with D73279-003.
- Retail Single - Intel® Eth Converged Nw Adapter X710-T4 Product Code X710T4 MM# 943052
 - Replace PBA J31241-004 with PBA J31241-005.
 - Replace clamshell D73279-002 with D73279-003.
- Retail Bulk - Intel® Eth Converged Nw Adapter X710-T4 Product Code X710T4BLK MM#943053
 - Replace PBA J31241-004 with PBA J31241-005.
 - Replace clamshell D73279-002 with D73279-003.

- As a result of this change, the PBA (printed board assembly) and TA (top assembly) numbers will roll as noted in the affected products table within this PCN notice. If the PBA/TA numbers are printed on any product or box labels, those will show the PBA/TA dash roll as well.
- Clamshell change for OEM-Gen, Retail Single and Retail Bulk to include Korean recycling logo.



Customer Impact of Change and Recommended Action:

The new PBA improves reliability with the use of all ceramic output caps in the two low voltage supplies, and improves yield with the removal of a via that would occasionally cause issues with manufacturing. There were absolutely no changes to any of the high speed nets; PCI, AFE, etc. No clock rates changed, no edge rates were modified. It is our opinion that this change requires minimal to no validation by our customer.

Intel anticipates no impact to customers

Customers can expect to receive mixed inventory until current inventory levels are depleted.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
X710T4	943052	J18259-002	J31241-004	J18259-003	J31241-005
X710T4BLK	943053	J18260-002	J31241-004	J18260-003	J31241-005
X710T4G1P5	943101	J18258-003	H64862-012	J18258-004	H64862-013

PCN Revision History:

Date of Revision:
April 7, 2017

Revision Number:
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Reason:
Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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